

CNZ1002 (ON1002)

Photo Interrupter

For contactless SW, object detection

■ Overview

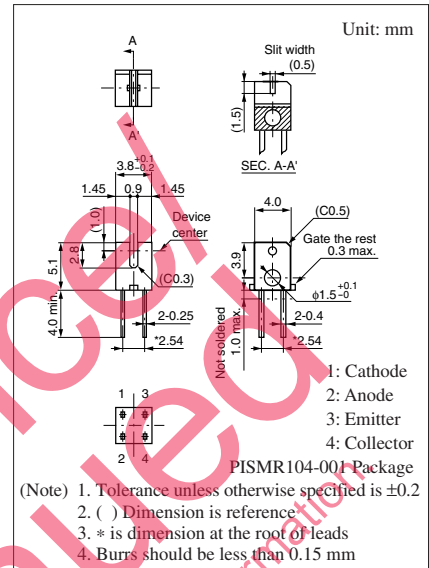
CNZ1002 is an ultraminiature, highly reliable transmissive photosensor in which a high efficiency GaAs infrared light emitting diode chip and a high sensitivity Si phototransistor chip are integrated in a double molded resin package.

■ Features

- Ultraminiature: 4.0 mm × 3.8 mm (height: 5.1 mm)
- Fast response: $t_r, t_f = 35 \mu s$ (typ.)
- Highly precise position detection: 0.25 mm
- Gap width: 0.9 mm

■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	Rating	Unit
Input (Light emitting diode)	Reverse voltage	V_R	6 V
	Forward current	I_F	50 mA
	Power dissipation *1	P_D	75 mW
Output (Photo transistor)	Collector-emitter voltage (Base open)	V_{CEO}	35 V
	Emitter-collector voltage (Base open)	V_{ECO}	6 V
	Collector current	I_C	20 mA
	Collector power dissipation *2	P_C	75 mW
	Temperature	Operating ambient temperature	T_{opr}
Storage temperature		T_{stg}	-40 to +100 °C



(Note) *1: Input power derating ratio is 1.0 mW/°C at $T_a \geq 25^\circ C$.
 *2: Output power derating ratio is 1.0 mW/°C at $T_a \geq 25^\circ C$.

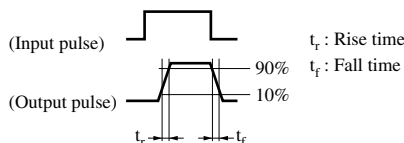
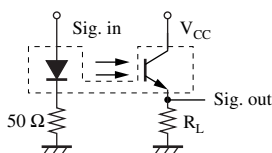
■ Electrical-Optical Characteristics $T_a = 25^\circ C \pm 3^\circ C$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input characteristics	Forward voltage	V_F $I_F = 20 \text{ mA}$		1.2	1.4	V
	Reverse current	I_R $V_R = 3 \text{ V}$			10	μA
Output characteristics	Collector-emitter cutoff current (Base open)	I_{CEO} $V_{CE} = 20 \text{ V}$			100	nA
Transfer characteristics	Collector current	I_C $V_{CE} = 5 \text{ V}, I_F = 1.5 \text{ mA}$	65		480	μA
	Collector-emitter saturation voltage	$V_{CE(sat)}$ $I_F = 3 \text{ mA}, I_C = 30 \mu A$			0.4	V
	Rise time *	t_r $V_{CC} = 5 \text{ V}, I_C = 0.1 \text{ mA}$		35		μs
	Fall time *	t_f $R_L = 1000 \Omega$			35	μs

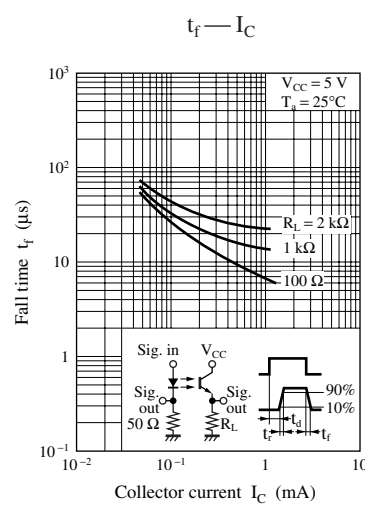
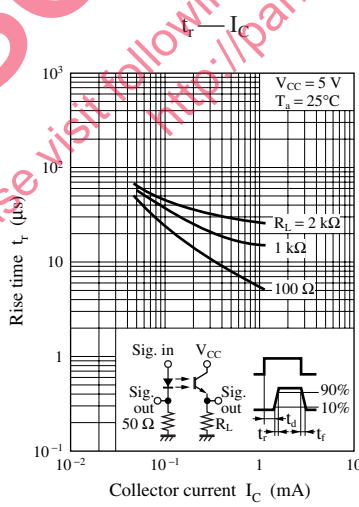
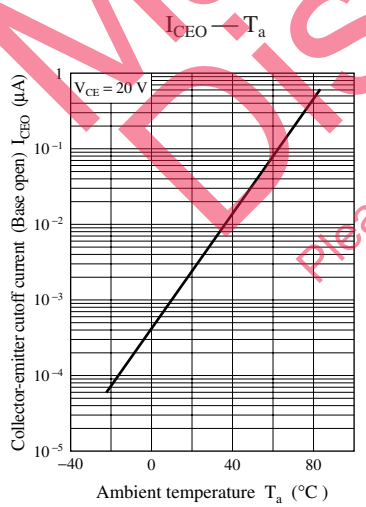
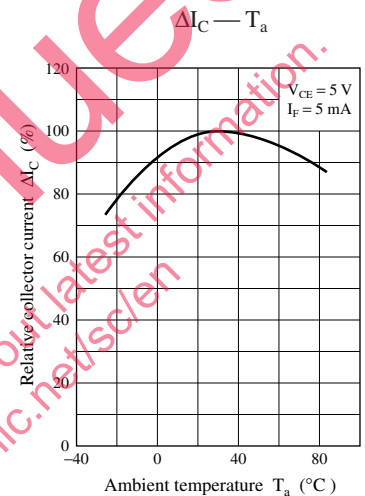
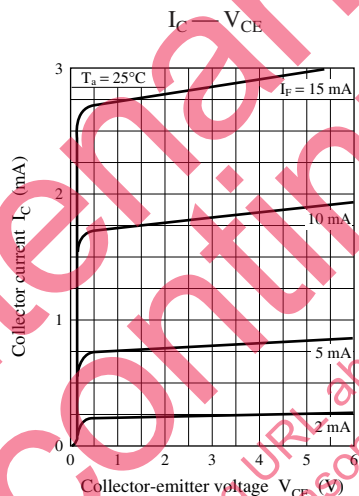
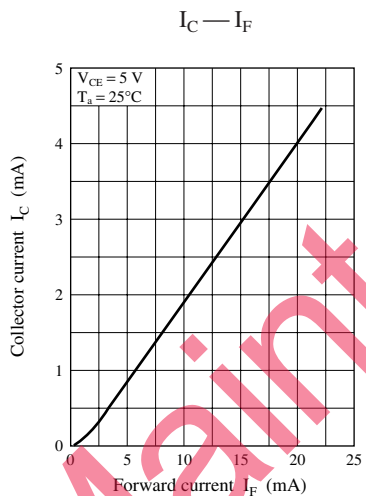
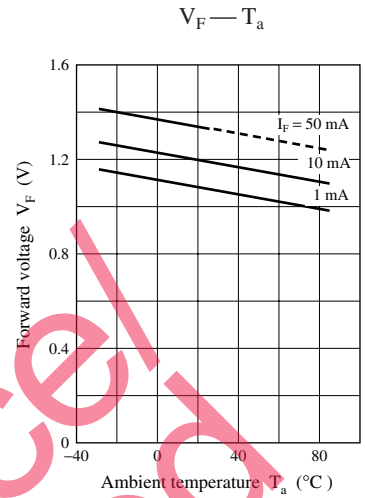
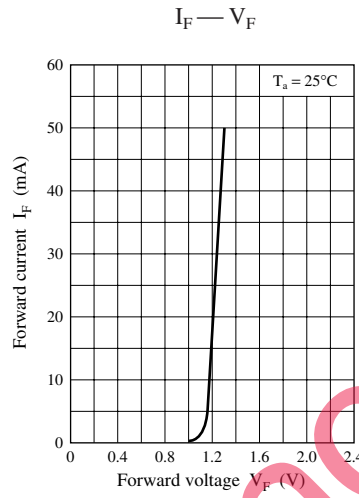
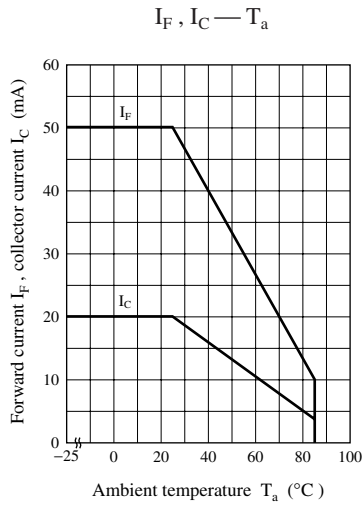
Note) 1. Input and output are practiced by electricity.

2. This device is designed by disregarded radiation.

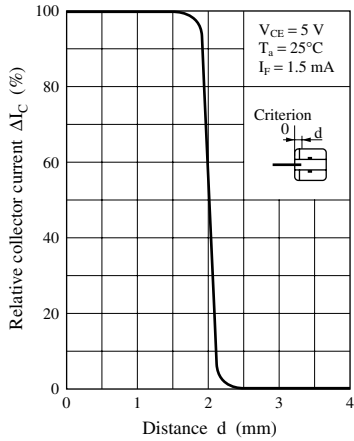
3. *: Switching time measurement circuit



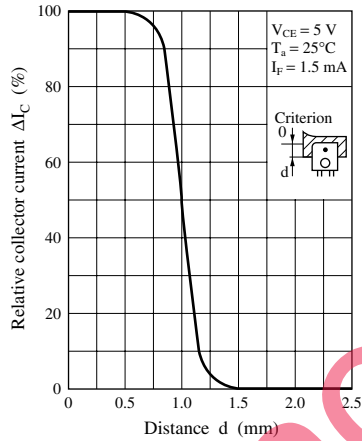
Note) The part number in the parenthesis shows conventional part number.



ΔI_C — d (1)



ΔI_C — d (2)



Maintenance Discontinued!

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■ This product contains Gallium Arsenide (GaAs).

GaAs powder and vapor are hazardous to human health if inhaled or ingested. Do not burn, destroy, cut, cleave off, or chemically dissolve the product. Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

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